



BSI Standards Publication

Device embedding assembly technology

Part 2-5: Guidelines — Implementation of a 3D data
format for device embedded substrate

National foreword

This British Standard is the UK implementation of EN IEC 62878-2-5:2019. It is identical to IEC 62878-2-5:2019. It supersedes PD IEC/PAS 62878-2-5:2015, which is withdrawn.

The UK participation in its preparation was entrusted to Technical Committee EPL/501, Electronic Assembly Technology.

A list of organizations represented on this committee can be obtained on request to its secretary.

This publication does not purport to include all the necessary provisions of a contract. Users are responsible for its correct application.

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Amendments/corrigenda issued since publication

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